



# 20A, 50V - 600V Super Fast Rectifier

#### **FEATURES**

- AEC-Q101 qualified available
- High efficiency, low V<sub>F</sub>
- High current capability
- High surge current capability
- Low power loss
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converters
- Switching mode converters and inverters
- Freewheeling application

#### **MECHANICAL DATA**

• Case: TO-220AB

Molding compound meets UL 94V-0 flammability rating
Terminal: Matte tin plated leads, solderable per J-STD-002

Mounting torque: 0.56 N·m maximum
Meet JESD 201 class 2 whisker test

Polarity: As marked

• Weight: 1.82g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I <sub>F</sub>	20	Α				
$V_{RRM}$	50 - 600	V				
I <sub>FSM</sub>	150	Α				
$T_{JMAX}$	150	°C				
Package	TO-220AB					
Configuration	Dual dies					

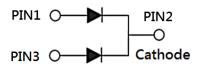








**TO-220AB** 



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)										
PARAMETER	SYMBOL	SF 2001G	SF 2002G	SF 2003G	SF 2004G	SF 2005G	SF 2006G	SF 2007G	SF 2008G	UNIT
Marking code on the device		SF 2001G	SF 2002G	SF 2003G	SF 2004G	SF 2005G	SF 2006G	SF 2007G	SF 2008G	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	300	400	500	600	<b>V</b>
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	210	280	350	420	<b>V</b>
Forward current	I <sub>F</sub>		20						Α	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	150						Α		
Junction temperature	TJ	-55 to +150					ç			
Storage temperature	T <sub>STG</sub>	-55 to +150					°C			

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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-case thermal resistance	R <sub>eJC</sub>	2.5	°C/W			

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage per diode <sup>(1)</sup>	SF2001G SF2002G SF2003G SF2004G	I <sub>F</sub> = 10A, T <sub>J</sub> = 25°C	V <sub>F</sub>	•	0.975	V	
	SF2005G SF2006G			ı	1.300	V	
	SF2007G SF2008G			-	1.700	V	
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		$T_J = 25^{\circ}C$	ı	-	5	μA	
		T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	400	μA	
Junction capacitance per diode		1MHz, $V_R = 4.0V$	CJ	80	-	pF	
Reverse recovery time		$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	35	ns	

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING				
SF20xG	TO-220AB	50 / Tube				
SF20xGH	TO-220AB	50 / Tube				

### Notes:

- 1. "x" defines voltage from 50V(SF2001G) to 600V(SF2008G)
- 2. "H" means AEC-Q101 qualified



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

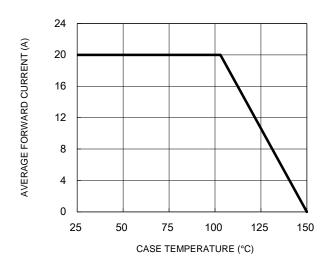


Fig.3 Typical Reverse Characteristics

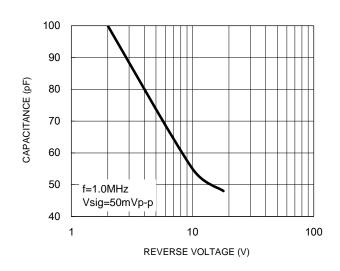
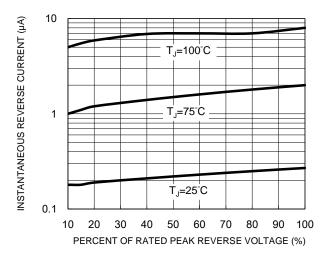


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



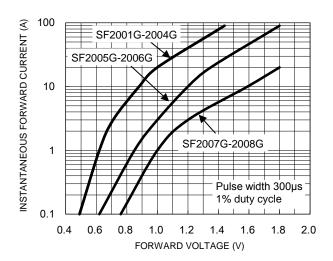
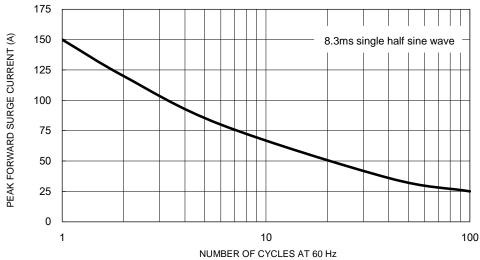


Fig.5 Maximum Non-Repetitive Forward Surge Current



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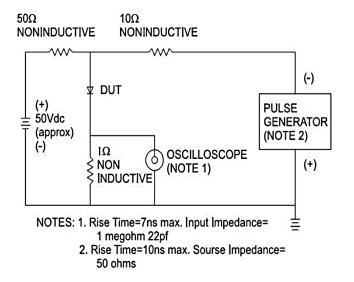


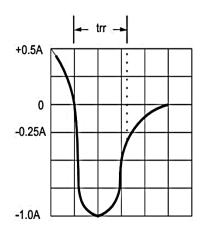
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### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

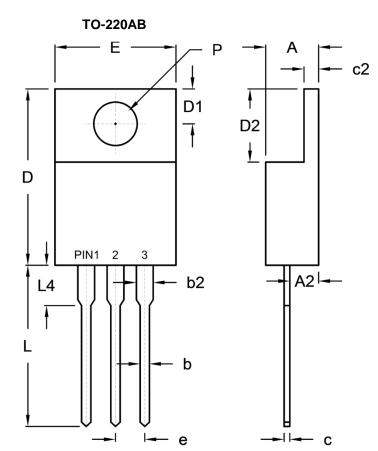








## **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	4.42	4.76	0.174	0.187	
A2	2.20	2.80	0.087	0.110	
b	0.68	0.94	0.027	0.037	
b2	1.14	1.77	0.045	0.070	
С	0.35	0.64	0.014	0.025	
c2	1.14	1.40	0.045	0.055	
D	14.60	16.00	0.575	0.630	
D1	2.62	3.44	0.103	0.135	
D2	5.84	6.86	0.230	0.270	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
L	13.19	14.79	0.519	0.582	
L4	2.80	4.20	0.110	0.165	
Р	3.54	4.00	0.139	0.157	

### **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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